

### 4.8mm Green Color LED Lamps S518TG2C

4.8 mm with InGaN dice  $\,\circ\,$ 

Encapsulated with White diffused (Milky) package °

Long Leads •

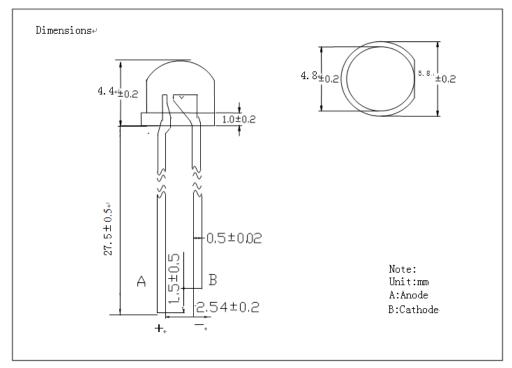
#### Absolute Maximum Ratings : ( Ta=25°C )

Parameter	Maximum Rating	Unit		
Peak Forward Current	120	mA		
Continuous Forward Current	30	mA		
Operating Temperature Range	$-40^{\circ}$ C to $+85^{\circ}$ C			
Storage Temperature Range	$-50^{\circ}$ C to $+100^{\circ}$ C			
Lead Soldering Temperature	$260^{\circ}$ C for 3 seconds			
	1.6mm(0.063 inch) from body			

### Electro-Optical Characteristics ( $Ta = 25^{\circ}C$ )

Parameter Radiant	Test Condition	Symbol	Min.	Тур.	Max.	Unit
Forward Voltage	IF = 20mA	VF	2.8	3.2	3.6	V
Luminous Intensity	IF = 20mA	Iv		200		mcd
Dominant Wavelength	IF = 20mA	λd	515	520	525	nm
Viewing Angle	IF = 20mA	riangle  heta		140		deg

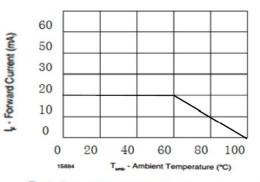
#### Package



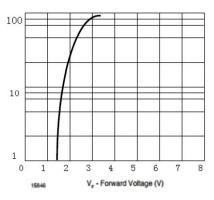


## YETDA INDUSTRY LTD.

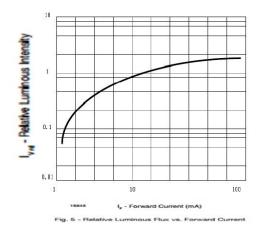
#### **Typical Electro-Optical Characteristics Curve:**

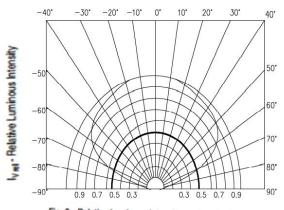




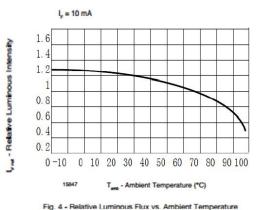












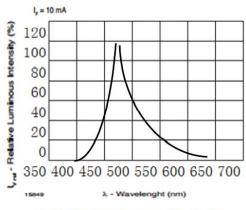


Fig. 6 - Relative Intensity vs. Wavelength

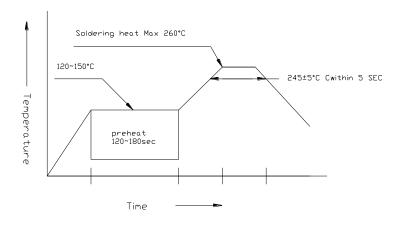


# YETDA INDUSTRY LTD.

#### •Soldering:

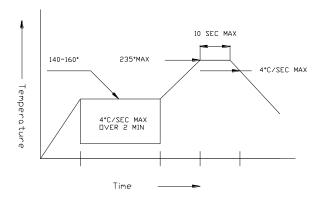
1. Manual of soldering

The temperature of the iron tip should not be higher than  $260^{\circ}$ C and Soldering within 3 seconds per solder-land is to be observed 2. DIP soldering (Wave Soldering): Preheating: $120^{\circ}$ C ~150^{\circ}C within 5 sec. $260^{\circ}$ C (Max) Gradual Cooling (Avoid quenching)



#### 3. Reflow Soldering

Preheating:  $140^{\circ}$ C ~ $160^{\circ}$ C ±5°C, within 2 minutes. Operation heating:  $235^{\circ}$ C (Max) within 10 seconds(Max) Gradual Cooling (Avoid quenching)



#### •Handling:

Care must be taken not to cause to the epoxy resin portion of Yetda LEDS while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of Yetda LEDS with hard or sharp article such as the sand blast and the metal hook